

AMP CT

TE Internal #: 2-292173-8 PCB Mount Header, Right Angle, Wire-to-Board, 8 Position, 2 mm [. 079 in] Centerline, Partially Shrouded, Tin, Surface Mount, Power & Signal, AMP CT

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Connectors > PCB Connectors > PCB Headers & Receptacles > AMP COMMON TERMINATION HEADERS



Connector System: Wire-to-Board Number of Positions: 8 Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Right Angle

All AMP COMMON TERMINATION HEADERS (33)



Features

Product Type Features

| Connector System | Wire-to-Board |
|-----------------------------------|-----------------------|
| Header Type | Partially Shrouded |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type | PCB Mount Header |
| Configuration Features | |
| Number of Positions | 8 |
| Number of Rows | 1 |
| PCB Mount Orientation | Right Angle |
| Electrical Characteristics | |
| Operating Voltage | 125 VAC |
| Body Features | |
| | |

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| Primary Product Color | Black |
|---|---------------------------------------|
| Contact Features | |
| | 4.2 mm[.165 in] |
| Contact Mating Area Length | |
| PCB Contact Termination Area Plating Material Thickness | 1 – 2 μm[39.37 – 78.73 μin] Inline |
| Contact Layout | |
| Mating Pin Diameter | .6 mm[.024 in] Round |
| Contact Shape & Form | |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Tin |
| Contact Type | Pin |
| Contact Current Rating (Max) | 4 A |
| Termination Features | |
| Round Termination Post & Tail Diameter | .6 mm[.024 in] |
| Termination Method to Printed Circuit Board | Surface Mount |
| Mechanical Attachment | |
| Mating Alignment Type | Polarization |
| Mating Retention | Without |
| Panel Mount Feature | With |
| PCB Mount Retention Type | Solder Peg |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | With |
| -lousing Features | |
| Housing Material | 6T PA(GF) |
| Centerline (Pitch) | 2 mm[.079 in] |
| Dimensions | |
| Connector Length | 17.8 mm[.701 in] |
| Connector Height | 5.8 mm[.228 in] |
| Connector Width | 9 mm[.354 in] |
| PCB Thickness (Recommended) | .8 mm[.031 – .063 in] |
| | |

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Usage Conditions

| Operating Temperature Range | -40 – 105 °C[-40 – 221 °F] |
|-----------------------------|----------------------------|
| Operation/Application | |
| Assembly Process Feature | Pick and Place Cover |
| Circuit Application | Power & Signal |
| Industry Standards | |
| Agency/Standard | CSA, UL |
| Approved Standards | CSA LR7189, UL E28476 |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Quantity | 500 |
| Packaging Type | Вох, Таре |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|------------------------------|-----------|
| EU ELV Directive 2000/53/EC | Compliant |

| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
|---|---|
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Reflow solder capable to 245°C |
| | |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

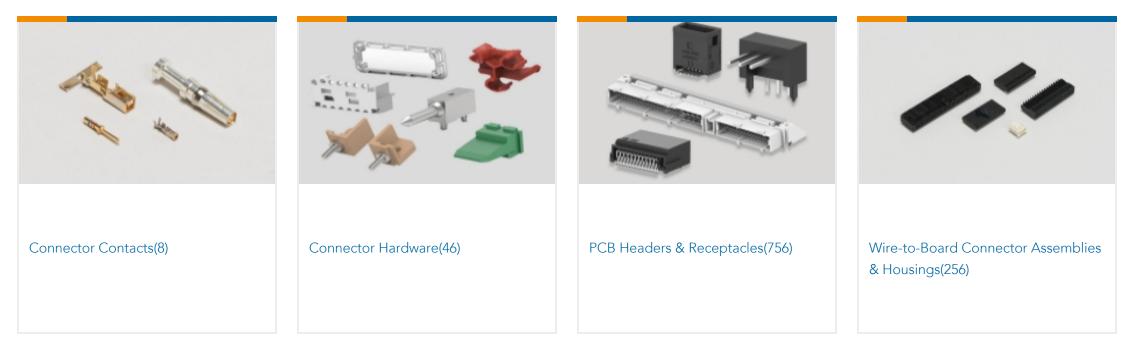
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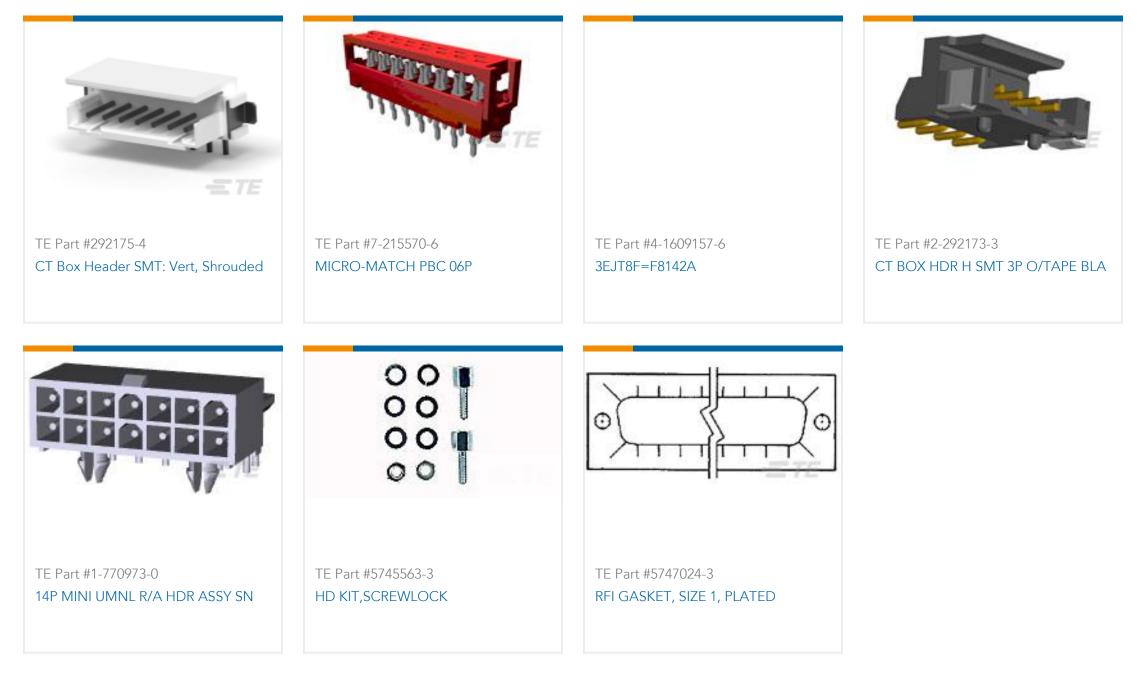
Compatible Parts



Also in the Series AMP CT



Customers Also Bought



Documents

CAD Files

3D PDF

3D

PCB Mount Header, Right Angle, Wire-to-Board, 8 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Surface Mount, Power & Signal, AMP CT



Customer View Model

ENG_CVM_CVM_2-292173-8_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-292173-8_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-292173-8_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications AMP COMMON TERMINATION (CT), CONNECTOR, 2mm PITCH, M/T TYPE, LEAD FREE VERSION

Japanese

Product Specification

Japanese

Product Environmental Compliance

TE Material Declaration

English

Agency Approvals CSA Certificate

English